

Doping of $\alpha-(\text{Al}_x\text{Ga}_{1-x})_2\text{O}_3$ using Suboxide Molecular-Beam Epitaxy

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Introduction

- Ga_2O_3 has an ultrawide-bandgap and high breakdown field making it a useful material for high power and ultra-high frequency devices¹
- Alloying Ga_2O_3 with Al_2O_3 extends the bandgap and breakdown field even further

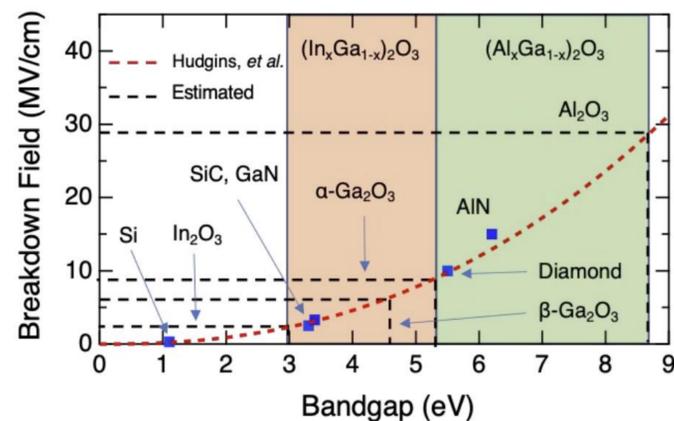


Figure Courtesy of Jon McCandless

- $\alpha-(\text{Al}_x\text{Ga}_{1-x})_2\text{O}_3$ has a bandgap ranging from 5.4-8.6 eV which can be tuned based on the Al composition²
- If successfully doped, $\alpha-(\text{Al}_x\text{Ga}_{1-x})_2\text{O}_3$ would be the highest bandgap and highest breakdown field semiconductor
- Molecular-beam Epitaxy (MBE) has grown the highest quality $\alpha-(\text{Al}_x\text{Ga}_{1-x})_2\text{O}_3$ films over the whole range of Al composition, but has slow growth rates, around 0.2 $\mu\text{m/hr}$, compared to other epitaxial growth methods³

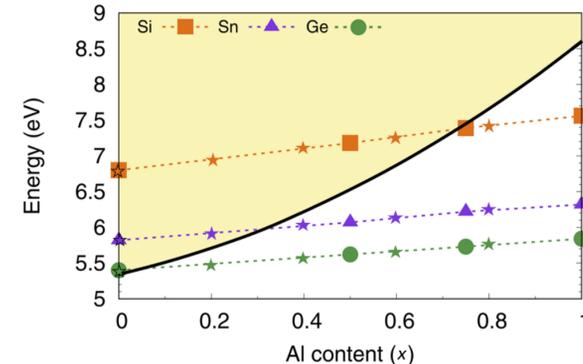
Methods

- All films were grown by S-MBE on A-plane Sapphire substrates
- X-ray diffraction (XRD) and X-ray reflectivity (XRR) were used to confirm film composition and thickness of each film
- The two-point resistance of each sample was measured using a multimeter

Methods

S-MBE^{4,5}

- Suboxide MBE (S-MBE) simplifies the growth reactions of for III-O materials, including Ga_2O_3 , growth allowing for increased growth rates while maintaining high film quality
- Observed Changes:
 - Increases growth rate
 - Allows for linear composition control
 - Increases accessible growth regime
 - Can grow whole Al composition range



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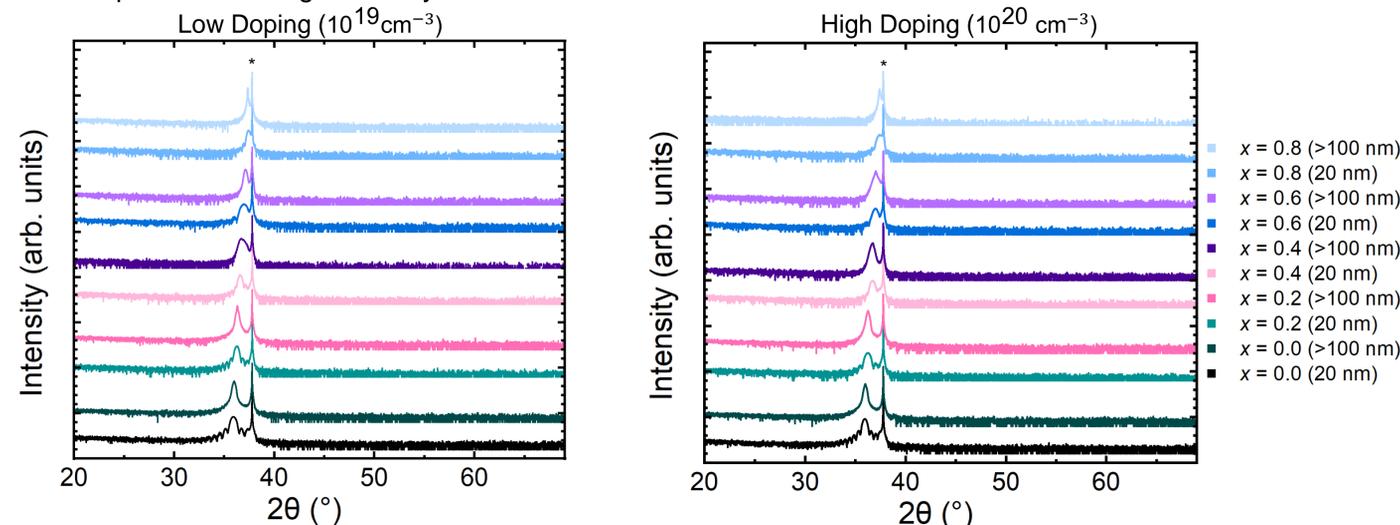
MOCATAXY⁶

- Metal-oxide-catalyzed epitaxy (MOCATAXY) utilizes a catalytic element to increase the growth rate through metal-exchange catalysis
- Sn and In catalyze Ga_2O_3 growth
- Potential Benefits:
 - Increases growth rate
 - Improves surface morphology
 - Stabilizes previously unstable phases
 - May enhance crystalline quality

- Previous computational work has predicted the Al composition at which dopants transition from shallow to deep donors in $\alpha-(\text{Al}_x\text{Ga}_{1-x})_2\text{O}_3$ ⁷
- The planned growth series will vary
 - Dopant (Sn⁸, Ge⁹, Si¹⁰)
 - Doping level (10^{19} , 10^{20} cm^{-3})
 - Film Composition (0, 20, 40, 60, 80% Al)
 - Thickness (~ 20 , $\geq 100 \text{ nm}$)

Results

- Films were not conductive enough to measure a resistance with a multimeter
 - Unclear if dopants are being incorporated into film during growth
- MOCATAXY was observed during growths with Sn
 - Growth rate increased
 - Composition no longer linearly controlled



Conclusions

- Sn doping resulted in insulating films at all tested conditions
- MOCATAXY observed during growths with Sn
- Further work is necessary to understand doping of $\alpha-(\text{Al}_x\text{Ga}_{1-x})_2\text{O}_3$ by S-MBE

Future Work

- Complete doping series for Si and Ge
- SIMS analysis to investigate incorporation of dopants in film
- High temperature hall measurements will be done on nonconductive films to see if donor activation will occur at nonstandard conditions
- Hall measurements to determine electron mobility and sheet carrier concentration of any conductive samples
- Ion implantation on undoped samples

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